

PRODUCT SPECIFICATION

产品规范

适用于

For

QM603 GNSS 模块

QM603 GNSS Module



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REVISION HISTORY / 修订历史

Revision/版本	Modification/更改	Date/日期
1.0	New Release / 新发	2023/5/31

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1. Introduction / 简介

QM603 GNSS is a full-system and full-frequency RTK positioning module developed by Shanghai QinNav Technology Co., Ltd. based on Quantum III Soc with fully independent intellectual property rights. Support BDS-2, BDS-3, GPS, GLONASS, Galileo, QZSS, IRNSS and other satellite system signal tracking, onboard IMU, support integrated navigation, suitable for surveying and mapping, robotics, foundation enhancement and other fields.

QM603 GNSS 是上海钦天导航技术有限公司基于具有完全自主知识产权的Quantum III Soc开发的全系统全频点RTK定位模块，支持BDS-2、BDS-3、GPS、GLONASS、Galileo、QZSS、IRNSS等卫星系统信号跟踪，板载IMU，支持组合导航，适用于测量测绘、机器人、地基增强等领域。

1.1. Product Characteristics / 产品特性

Table 1. Product Characteristics / 产品特性

Characteristics		QM603	
Signals 信号	Positioning 定位	GPS: L1C/A, L2P, L2C, L5, L1C	
		BDS-2: B1I, B2I, B3I	
		BDS-3: B1I, B3I, B1C, B2a, B2b	
		GLONASS: G1, G2, G3*	
		Galileo: E1, E5b, E5a, E5 AltBoC*, E6c*	
		QZSS: L1C/A, L2C, L5, L1C*	
		SBAS: L1C/A, L5*	
		IRNSS: L5*	
	L-Band*		
Items with * will be adjusted with the version. 带*项会随同版本进行调整。			
Time to First Fix 首次定位时间	Cold Start 冷启动	< 20s （Adding Acceleration Capture Module,增加捕获加速模块）	
	Hot Start (with RTC) 热启动（使用RTC）	< 10s （Typical,典型）	

Signal Capture 信号捕获	Reacquisition 失锁重捕	< 1s
	Signal Capture Sensitivity 信号捕获灵敏度	-138dBm
	Signal Tracking Sensitivity 信号跟踪灵敏度	-153dBm
Measurement Precision 测量准确度	Pseudo-range Precision 伪距精度	$\leq 10\text{cm}$
	Carrier Phase Precision 载波相位精度	$\leq 1\text{mm}$
Accuracy 精度	PPS (RMS) 授时精度	20ns
	SPP Accuracy 标准单点定位精度	$H \leq 1.5\text{m}, V \leq 3\text{m} (1\sigma, \text{PDOP} \leq 4)$
	Static Differential Accuracy (Supported by Compass Solution) 静态差分精度 (Compass Solution 软件支持)	$H: \pm(2.5+1 \times 10^{-6} \times D) \text{ mm}$ $V: \pm(5.0+1 \times 10^{-6} \times D) \text{ mm}$ D为基线长度(单位: mm) D - Baseline length (Unit: mm)
	Speed Accuracy 测速精度	$\leq 0.02 \text{ m/s} (\text{PDOP} \leq 4)$
Anti-interference 抗干扰	It can suppress the potential narrowband and single tone radio interference signals in the GNSS signal frequency band, and the interference to signal ratio can reach 50dB. 具备抑制GNSS信号频带内潜在的窄带和单音无线电干扰信号，干信比可达 50dB。	
RTK	RTK Initialization Time RTK初始化时间	< 5s (baseline < 10km, 基线长小于 10km)

	Initialization Reliability 初始化置信度	> 99.9 %
	RTK Accuracy RTK精度	$H: \pm (8 + 10^{-6} \times D) \text{ mm}$ $V: \pm (15 + 10^{-6} \times D) \text{ mm}$ D为基线长度(单位: mm) D - Baseline length (Unit: mm)
Data Rates 数据速率	Measurements & Position 测量&定位	Max 20Hz (Optional, 选配项)
	RTK: Positioning RTK: 定位	Max 20Hz (Optional, 选配项)
Electrical 电气特性	Voltage 供电电压	+ 3.3 V ~ 3.45 V DC
	Power Consumption 功耗	0.95 W (Anti-interference off, 未开启抗干扰) Set anti-interference on consumes more about 0.2W 抗干扰功能开启, 功耗约增加 0.2W
Environmental 环境要求	Operating Temperature 工作温度	-40°C ~ +85°C
	Storage Temperature 储存温度	-55°C ~ +95°C
Data Formats 输出数据格式	NMEA-0183	GPGGA, GPGSV, GPGLL, GPGSA, GPGST, GPHDT, GPRMC, GPVTG, GPZDA etc.
	ComNav Binary (CNB) 司南二进制格式	ComNav Self-Defined Binary 司南自定义二进制
	CMR(GPS)	CMROBS, CMRREF
	RTCM2.X	RTCM1, RTCM3, RTCM31
	RTCM3.X	1004~1008,1012,1019,1020,1033,1042,1045/1046,

		1230 MSM3~MSM7:1073~1077,1083~1087,1123~1127,1093~1097
Antenna Interface 天线接口	Impedance Matching 阻抗匹配	Wiring 50 Ohm impedance matching 布线 50 欧姆阻抗匹配
	Ant Power 天线供电电压	External 外部供电: +3.3V ~ +5V @ 0-100mA
	Ant Gain 天线增益	20 ~ 35dB Antenna gain is lower than 20dB or higher than 35dB, which may cause signal crosstalk and other problems. 增益低于 20dB或者高于 35dB,可能会造成信号串扰等问题
Hardware Interface 硬件接口		LGA (82Pin) UARTx4, PPSx1, EVENTx2, SPIx1
Physical 物理参数	Size 尺寸	30mm×30mm×3.2mm
	Weight 重量	6.6 grams (克)
	Flatness 平整度	≤ 0.1mm

2. QM603 Product Size / QM603 尺寸

In this section, product photo, three-side views and the dimension of QM603 is provided for customers' further hardware design and installation.

本节提供了QM603的实物图，三视图和对应的物理尺寸，便于用户进一步系统硬件设计和安装。



Figure 1. QM603 Product Photo / QM603 实物图

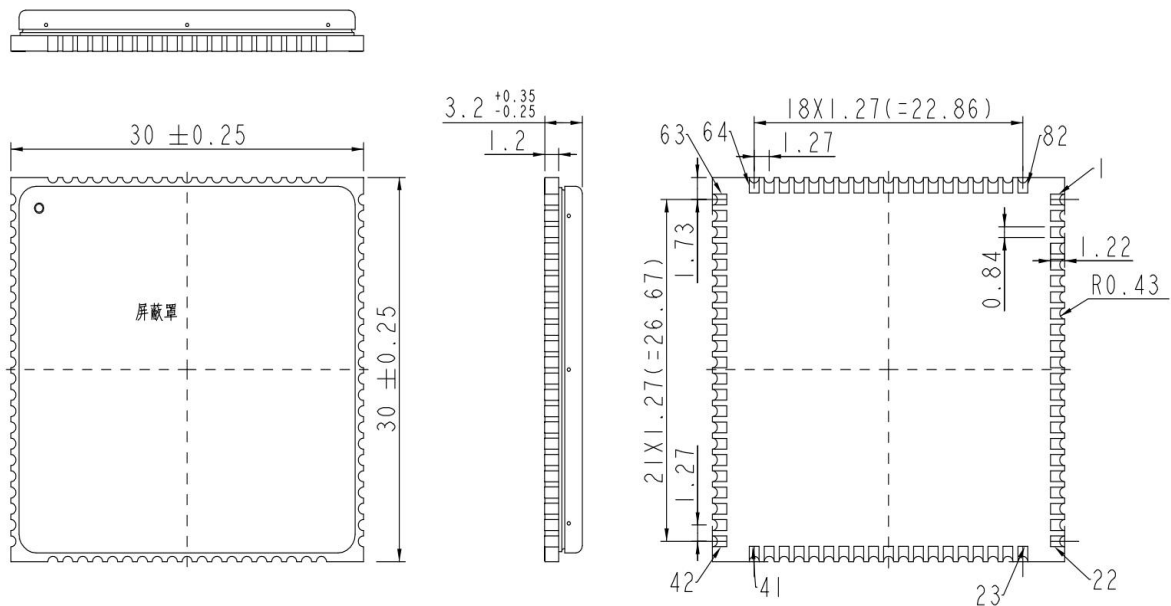


Figure 2. QM603 Dimension View / QM603 三视图

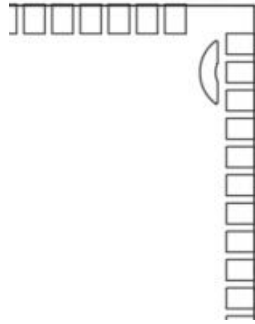


Figure 3. QM603 Bottom Section View / QM603 底部部分视图

Note: Because there is a half-moon window exposed tin position near the bottom of K803 module 62Pin, it is recommended that the pad should not be expanded outward when the user is packaged, otherwise it will be short-circuited.

注意：因为QM603模块62Pin附近底部有半月形开窗露锡位置，建议用户封装时，焊盘尽量不要往外扩，否则会短路。

3. Pin Arrangement and Definition / 针脚标识和定义

QM603 is surface-mount OEM Module which integrates 82 Pin (pitch 1.27mm).

QM603包括82Pin，表贴式模块（pitch 1.27mm）。

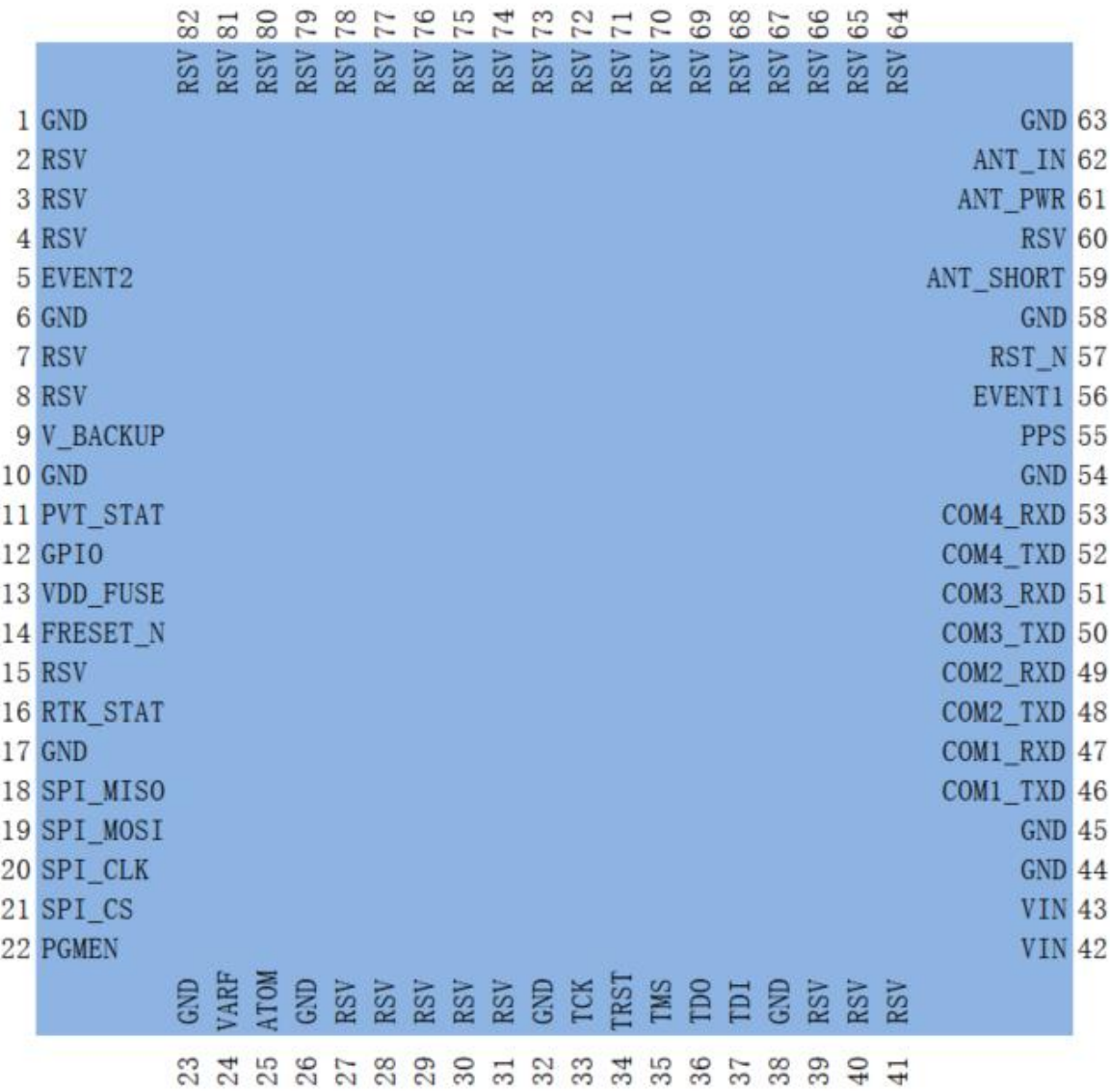


Figure 4. QM603 Includes 82-Pin Pad / QM603 包括82连接焊盘

Table 2. Pin Definition of QM603 82-Pin Pad / QM603 82针脚焊盘的针脚定义

Pin	Signal	Type	Description	
1	GND	GND	Ground Reference	参考地
2~4	RSV	/	Reserve (Float)	保留管脚（悬空）
5	EVENT2	I	Event Mark	外部事件输入

Pin	Signal	Type	Description	
6	GND	GND	Ground Reference	参考地
7~8	RSV	/	Reserve (Float)	保留管脚（悬空）
9	V_BACKUP	PWR	Power Supply for Internal RTC	外接RTC电池
10	GND	GND	Ground Reference	参考地
11	PVT_STAT	O	PVT Status	搜星时，模块搜星数与高电平脉冲数一致；不搜星时，5S输出一次高电平
12	GPIO	I/O	General-Purpose Input/Output	通用IO
13	VDD_FUSE	PWR	Power Supply for Internal FUSE (Float)	FUSE烧录电源输入（悬空）
14	FRESET_N	I	Reset to Factory Mode (Active Low)	复位为出厂模式（低电平有效）
15	RSV	/	Reserve (Float)	保留管脚（悬空）
16	RTK_STAT	O	RTK Data LED Indicator	在接收或发送差分信号时会输出高电平脉冲，其他状态输出低电平
17	GND	GND	Ground Reference	参考地
18	SPI_MISO	I	SPI_MISO	SPI主输入从输出信号
19	SPI_MOSI	O	SPI_MOSI	SPI主输出从输入信号
20	SPI_CLK	O	SPI_CLK	SPI总线时钟信号
21	SPI_CS	O	SPI_CS	SPI总线片选信号
22	PGMEN	I	Program Enable (Float)	烧录使能（悬空）
23	GND	GND	Ground Reference	参考地
24	VARF	O	Square Wave Output	方波输出
25	ATOM*	I	Atomic Clock Input	原子钟输入
26	GND	GND	Ground Reference	参考地
27~31	RSV	/	Reserve (Float)	保留管脚（悬空）
32	GND	GND	Ground Reference	参考地
33	TCK	I	JTAG TCK (Float)	JTAG TCK（悬空）
34	TRST	I	JTAG TRST (Float)	JTAG TRST（悬空）
35	TMS	I	JTAG TMS (Float)	JTAG TMS（悬空）
36	TDO	O	JTAG TDO (Float)	JTAG TDO（悬空）
37	TDI	I	JTAG TDI (Float)	JTAG TDI（悬空）
38	GND	GND	Ground Reference	参考地
39~41	RSV	/	Reserve (Float)	保留管脚（悬空）
42~43	VIN	PWR	DC Power Supply for Module (3.3V)	模块供电电源（+3.3V）
44~45	GND	GND	Ground Reference	参考地
46	COM1_TXD	O	Transmitted Data for COM1 Output	串口1输出信号
47	COM1_RXD	I	Received Data for COM1 Input	串口1输入信号
48	COM2_TXD	O	Transmitted Data for COM2 Output	串口2输出信号
49	COM2_RXD	I	Received Data for COM2 Input	串口2输入信号
50	COM3_TXD	O	Transmitted Data for COM3 Output	串口3输出信号

Pin	Signal	Type	Description	
51	COM3_RXD	I	Received Data for COM3 Input	串口3输入信号
52	COM4_TXD	O	Transmitted Data for COM4 Output	串口4输出信号
53	COM4_RXD	I	Received Data for COM4 Input	串口4输入信号
54	GND	GND	Ground Reference	参考地
55	PPS	O	Pulse Output Synchronized to OEM Time	同步卫星时间脉冲
56	EVENT1	I	Event Mark	外部事件输入
57	RST_N	I	Quick Reset without Clearing User Configuration (Low Active)	快速复位，不清除用户配置（低电平有效）
58	GND	PWR	Ground Reference	参考地
59	ANT_SHORT	O	Short Indication of Antenna (Low Active)	天线短路指示(低电平有效)
60	RSV	/	Reserve (Float)	保留管脚（悬空）
61	ANT_PWR	PWR	Power Supply for External GNSS Antenna LNA	外部GNSS天线供电
62	ANT_IN	I	GNSS Antenna	GNSS天线输入
63	GND	GND	Ground Reference	参考地
64~82	RSV	/	Reserve (Float)	保留管脚（悬空）
Items with * will be adjusted with the version. 带*项会随同版本进行调整。				

3.1. Remarks / 说明

1. Electrical Characteristics / 电气特性

COM1/2/3/4(TX&RX), SPI, ANT_SHORT, JTAG, GPIO, FRESET_N, RTK_STAT, PGMEN, RST_N, PPS EVENT1 and EVENT2 are LVCMOS 3.3V level, All these signals are LVCMOS/LVTTL 3.3V compatible.

COM1/2/3/4 (TX&RX) , SPI, ANT_SHORT, JTAG, GPIO, FRESET_N, RTK_STAT, PGMEN, RST_N, PPS, EVENT1和EVENT2为LVCMOS 3.3V 电平，所有这些信号均兼容LVCMOS / LVTTL 3.3V。

Table 3. LVCMOS 3.3V Electrical Standard / LVCMOS 3.3V电气标准

Symbols 符号	Description 描述	Min 最小	Max 最大
V _{IH}	Input high voltage 输入高电压	2.0V	VCC+0.3V
V _{IL}	Input low voltage 输入低电压	-0.3V	0.8V
V _{OH}	High-level output voltage 高电平输出电压	VCC-0.4V	--
V _{OL}	Low-level output voltage 低电平输出电压	--	0.41V
I _{OH}	Sourcing current 拉电流		8mA
I _{OL}	Sinking current		8mA

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灌电流

Table 4. LVTTTL 3.3V Electrical Standard / LVTTTL 3.3V电气标准

Symbols 符号	Description 描述	Min 最小	Max 最大
V _{IH}	Input high voltage 输入高电压	2.0V	VCC+0.3V
V _{IL}	Input low voltage 输入低电压	-0.3V	0.8V
V _{OH}	High-level output voltage 高电平输出电压	VCC-0.4V	--
V _{OL}	Low-level output voltage 低电平输出电压	--	0.41V
I _{OH}	Sourcing current 拉电流		8mA
I _{OL}	Sinking current 灌电流		8mA

2. Can withstand Voltage Range / 能承受的电压范围

The signal with the maximum voltage range from -0.3V to 3.6V is as follows: COM1/2/3/4 (TX&RX), SPI, ANT_SHORT, JTAG, PVT_STAT, FRESET_N, RTK_STAT, PGMEN, RST_N, PPS, EVENT1 and EVENT2.

所能承受电压的最大值范围是-0.3V~3.6V的信号如下：COM1/2/3/4（TX&RX），SPI，ANT_SHORT，JTAG，PVT_STAT，FRESET_N，RTK_STAT，PGMEN，RST_N，PPS，EVENT1和EVENT2。

3. Supply Voltage / 供电电压

VIN main power supply, voltage range: 3.15V~3.45V (DC), voltage ripple and spikes require less than 50mV. QM603: ANT_PWR, voltage range: 3.3V ~ 5.5V (DC), voltage ripple and spikes require less than 50mV. V_BACKUP operating voltage 1.8V~3.6V, voltage ripple and spike pulse requirements are less than 30mV; When charging the Farrah capacitor, V_BACKUP voltage reference circuit, voltage ripple and spike pulse requirements are less than 30mV.

VIN主供电电源，电压范围：3.15V~3.45V（直流），电压纹波和尖峰脉冲要求小于50mV。QM603：ANT_PWR，电压范围：3.3V~5.5V（直流），电压纹波和尖峰脉冲要求小于50mV。V_BACKUP工作电压1.8V~3.6V，电压纹波和尖峰脉冲要求小于30mV；给法拉电容充电时，V_BACKUP电压参考电路，电压纹波和尖峰脉冲要求小于30mV。

4. Add Surge Protection / 增加浪涌保护

QM603 module can feed the antenna from the inside. To prevent lightning strikes and surges, and prevent the feed current limiting chip inside the module from being damaged, you are advised to power the antenna from the outside of the module and add the surge protection function.

If you need to feed the antenna from the outside, it is recommended to use a high-voltage, high-power feeder chip; or add high-power protection devices such as gas discharge tubes, varistors, and TVS tubes to the feeder circuit.

QM603模块拥有从内部为天线馈电的功能，但为了有效防雷击、防浪涌，防止模块内部的馈电限流芯片损坏,建议用户从模块外部给天线供电并增加浪涌保护功能。

如需从外部为天线馈电，建议选用高耐压、大功率的馈电芯片；或在馈电电路上增设气体放电管、压敏电阻、TVS管等大功率的防护器件。

5. Antenna Short Circuit Description / 天线短路说明

When using the internal feed of the board, the following situations will occur:

- 1) When the antenna is normal, Pin 59 outputs high level;
- 2) When the antenna is short circuited, Pin 59 outputs low level

当使用板卡内部馈电时，会出现如下情况：

- 1) 天线正常时，Pin 59输出高电平；
- 2) 天线短路时，Pin 59输出低电平；

6. Hardware Integration Considerations / 硬件集成注意事项

- 1) VCC power-on has good monotonicity, and the initial level is lower than 0.4V, and the upstroke and ringing are guaranteed within the range of 5% VCC;
- 2) Use the VCC pin to provide a reliable power supply and all GND pins of the module are grounded;
- 3) Connect the ANT_IN signal to the antenna, pay attention to the 50 ohm impedance matching of the line;
- 4) The ANT_PWR pin is connected to +3.3~5.5V voltage, and then provides +3.3~5.5V feed to the antenna through the ANT_IN pin;
- 5) The module reset pin FRESET_N is for restoring the factory settings of the module, and RST_N is for quick reset. Please connect it correctly to ensure that the module can be reset reliably;
- 6) Special attention should be paid to:
Power supply: The guarantee of stable and low ripple power supply, the peak-to-peak value of the ripple voltage is preferably not higher than 50mVpp. It is recommended to use a power chip with a current output capacity greater than 2A to supply power to the module.
In addition to using LDO to ensure the power supply is pure, it is also necessary to consider:
 - ① Widening the power traces or using split copper surfaces to transmit current;
 - ② Place the LDO as close to the module as possible in the layout;
 - ③ Avoid the power traces passing through high power with high inductance devices such as magnetic coils.
- 7) Antenna interface: The antenna line is as short and smooth as possible, avoiding acute angles; pay attention to 50ohm impedance matching;
- 8) Avoid wiring directly under QM603;
- 9) The module is as far away from the high temperature airflow as possible.

- 1) VCC上电具有良好的单调性，且起始电平低于0.4V，上冲与振铃保障在5%VCC范围内；
- 2) 用VCC引脚提供可靠的电源且模块所有GND引脚接地；

- 3) 连接ANT_IN信号至天线,注意线路50欧姆阻抗匹配;
- 4) ANT_PWR脚接入+3.3~5.5V电压,再经由ANT_IN脚对天线提供+3.3~5.5V的馈电;
- 5) 模块复位引脚FRESET_N为恢复模块出厂设置, RST_N为快速复位, 请正确连接以保证模块可以可靠复位;
- 6) 在设计中应特别注意:
供电: 稳定及低纹波电源的保证, 纹波电压峰峰值最好不高于50mVpp。建议采用电流输出能力大于2A的电源芯片给模块供电。
除了可采用LDO保证供电纯净外, 还需要考虑:
 - ① 加宽电源走线或采用分割铺铜面来传输电流;
 - ② 布局上尽量将LDO靠近模块放置;
 - ③ 电源走线避免经过大功率与高感抗器件如磁性线圈。
- 7) 天线接口: 天线线路尽量短且顺畅, 避免走锐角; 注意50ohm阻抗匹配;
- 8) 避免在QM603正下方走线;
- 9) 模块尽量远离高温气流。

7. Static Electricity Protection / 静电保护

Some components on QM603 module are easily damaged by static electricity, which in turn affects the IC circuit and other components. Therefore, you should pay attention to electrostatic protection measures when using it.

- 1) When handling the module, try to wear gloves or finger cots and an anti-static wrist strap that meets the electrostatic protection standards;
- 2) During the process of taking the module, only the edge of the board should be taken, and the solder joints, circuit parts or components should not be directly touched to avoid sweat fingerprints from contaminating the solder joints;
- 3) The module should be protected by a soft protective pad between the module and the module interval during transportation;
- 4) When the module is idle, it should be placed on a soft protective pad (such as anti-static sponge pad, etc.), and do not stack at will;
- 5) The modules should be placed neatly and orderly, with a certain interval between modules to avoid collision with each other;
- 6) The module should be handled with care during use to prevent the module from being damaged by rough operation;
- 7) When powering on, pay attention to the positive and negative poles of the power supply and the voltage to avoid reverse connection and excessive voltage from burning the module;
- 8) When soldering the module to the motherboard, please ensure that the GND is soldered first, and then the ANT_IN pin;
- 9) When handling ANT_IN pin, do not touch any live capacitance or material (e.g., surface mount antenna, coaxial cable, wire iron, etc.) to avoid damage to the ANT_IN pin by the charge generated or stored by said capacitor or material;
- 10) Please make sure to solder the ANT_IN pin with an electrical protection iron.

QM603模块上的部分元器件易受静电影响而损坏, 进而影响IC电路及其他元件。因此在使用时应注意做好静电保护措施。

- 1) 拿取模块时应尽量戴好手套或者指套以及符合静电防护标准的防静电腕带;
- 2) 模块拿取过程中应只拿取板卡的边缘部位, 不能直接接触焊点, 线路部分或者元器件, 避免汗液指印污染焊点;
- 3) 模块在运输过程中模块与模块间隔之间应该采用软性防护垫进行保护;
- 4) 模块闲置时应放置在软性防护垫上(如防静电海绵垫等), 不要随意堆叠;
- 5) 模块摆放应摆放整齐有序, 模块之间保持一定间隔, 避免相互碰撞;

- 6) 模块在使用过程中应该轻拿轻放，防止粗暴作业损坏模块；
- 7) 上电时，注意电源正负极以及电压，避免反接和电压过高烧毁模块；
- 8) 将模块焊接到主板时，请确保GND先焊接，然后再焊接ANT_IN引脚；
- 9) 处理ANT_IN引脚时，请不要接触任何带电电容或材料（例如表贴天线、同轴电缆、电烙铁等），以免所述电容或材料所产生或存储的电荷损坏ANT_IN引脚；
- 10) 请确保使用带电保护的电烙铁焊接ANT_IN引脚。

4. Assembling & Repairing Note / 装配及维修说明

4.1. Module Assembling Note / 模块装配说明

QM603 is surface mounted, SMT welding is recommended for assembly.

QM603为表贴式模块，推荐使用SMT的焊接方式进行装配。

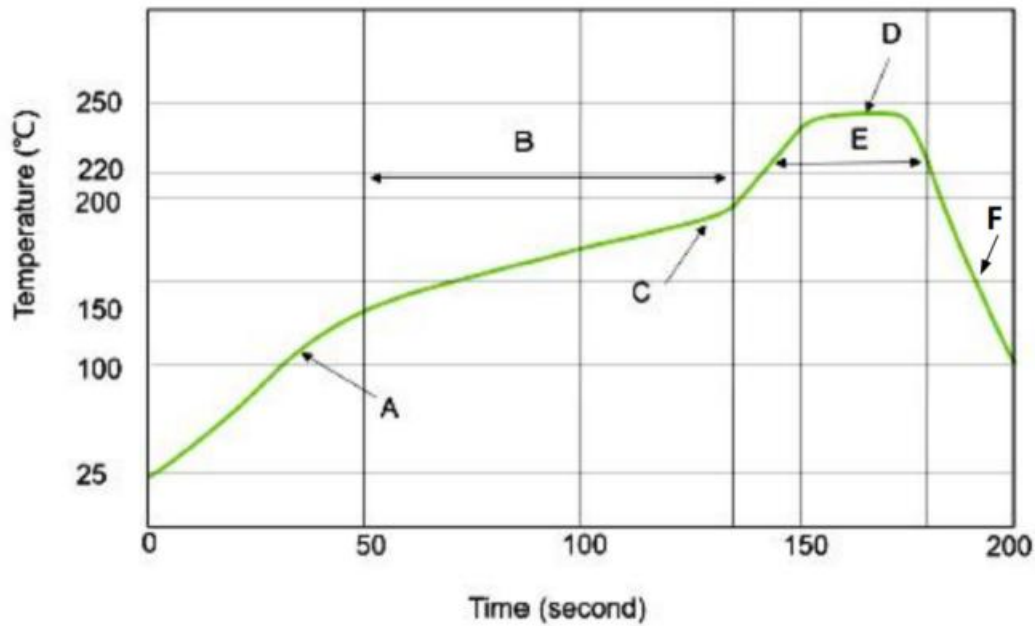


Figure 5. Furnace Temperature Curve / 炉温曲线

The process temperature limits are as follows:

- A: Heating Zone: Rising Slope: $1 \sim 3^{\circ}\text{C} / \text{sec}$
- B: Constant Temperature Zone: Range: $150 \sim 190^{\circ}\text{C}$ Time: $80 \sim 110\text{ S}$
- C: Constant Temperature $\rightarrow$ Reflow Zone: Rising Slope: $1 \sim 3^{\circ}\text{C} / \text{sec}$
- D: Peak Temperature: $235 \sim 245^{\circ}\text{C}$
- E: Reflow Zone: Range: Over 220°C Time: $50 \sim 80\text{ S}$
- F: Descent Slope: $-5^{\circ}\text{C} \sim -1^{\circ}\text{C} / \text{sec}$

制程温度界限如下:

- A: 升温区: 斜率: $1 \sim 3^{\circ}\text{C} / \text{sec}$
- B: 恒温区: $150 \sim 190^{\circ}\text{C}$ 时间: $80 \sim 110\text{S}$
- C: 恒温 $\rightarrow$ 回流区: 斜率: $1 \sim 3^{\circ}\text{C} / \text{sec}$
- D: 峰值温度: $235 \sim 245^{\circ}\text{C}$
- E: 回流区: 大于 220°C 时间: $50 \sim 80\text{S}$
- F: 下降斜率: $-5 \sim -1^{\circ}\text{C} / \text{sec}$

In order to prevent the module from being damaged by repeated heating, it is recommended to place the module after finishing the first side of PCB board.

为避免模块因反复受热而损坏，建议在完成PCB板第一面的回流焊之后再贴模块。

4.2. Repairing Note / 维修说明

When disassembling the module, it is suggested using a BGA welding bench. Please use correct air tuyere and choose certain temperature curve. Keep peak temperature under 245°C, rising slope under 3°C/s.

拆卸模块时，请使用BGA返修台，选择适合尺寸的风嘴并使用合适的温度曲线，最高温度不超过245°C，升温斜率不超过3°C/s。

5. Application Connection Example / 应用连接示例

In this section, an application connection example of QM603 OEM Module is presented via specific schematic diagrams. Per the instruction of these diagrams, you could easily build the communication circuits between QM603 OEM Module and other terminals such as PC, GPRS or Bluetooth module, and some other devices with an UART.

本部分以具体电路的形式提供一个QM603模块应用连接示例。参照下面的图示，您可以很方便建立QM603模块和其他终端（如PC，GPRS模块，蓝牙模块或其他带有UART的设备）之间的通讯电路。

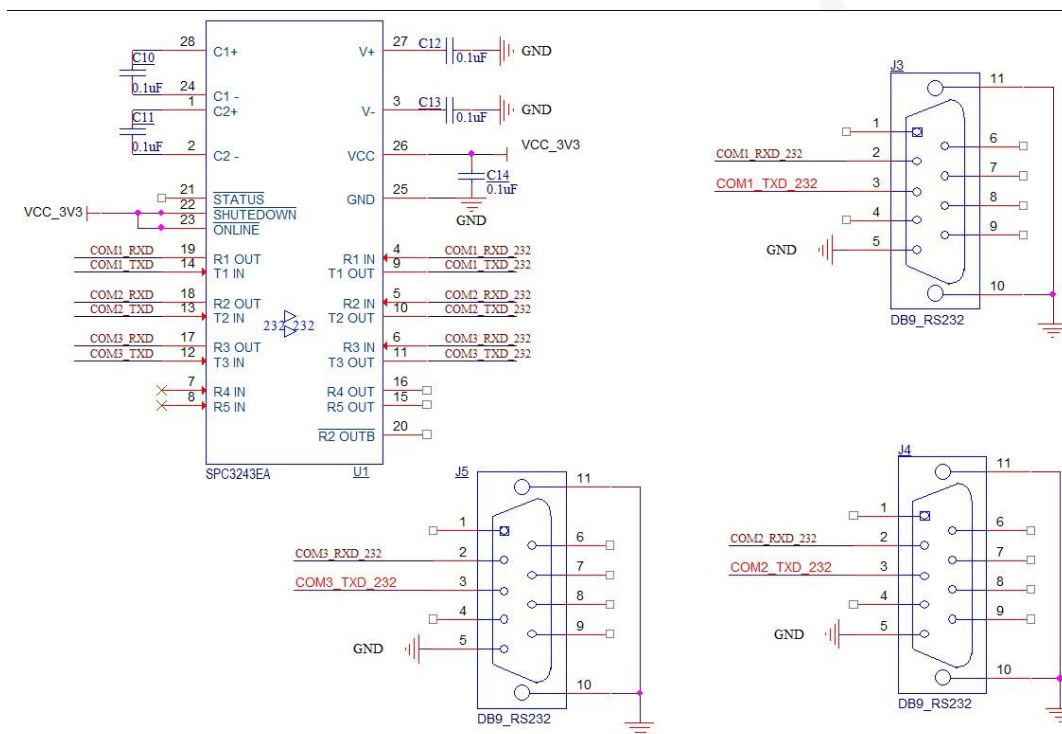


Figure 6. Connections between RS232 COM1, 2, 3 of QM603 and Some Other Devices with An UART / QM603 RS232 COM1、2、3与其他使用UART接口的设备之间的连接示意

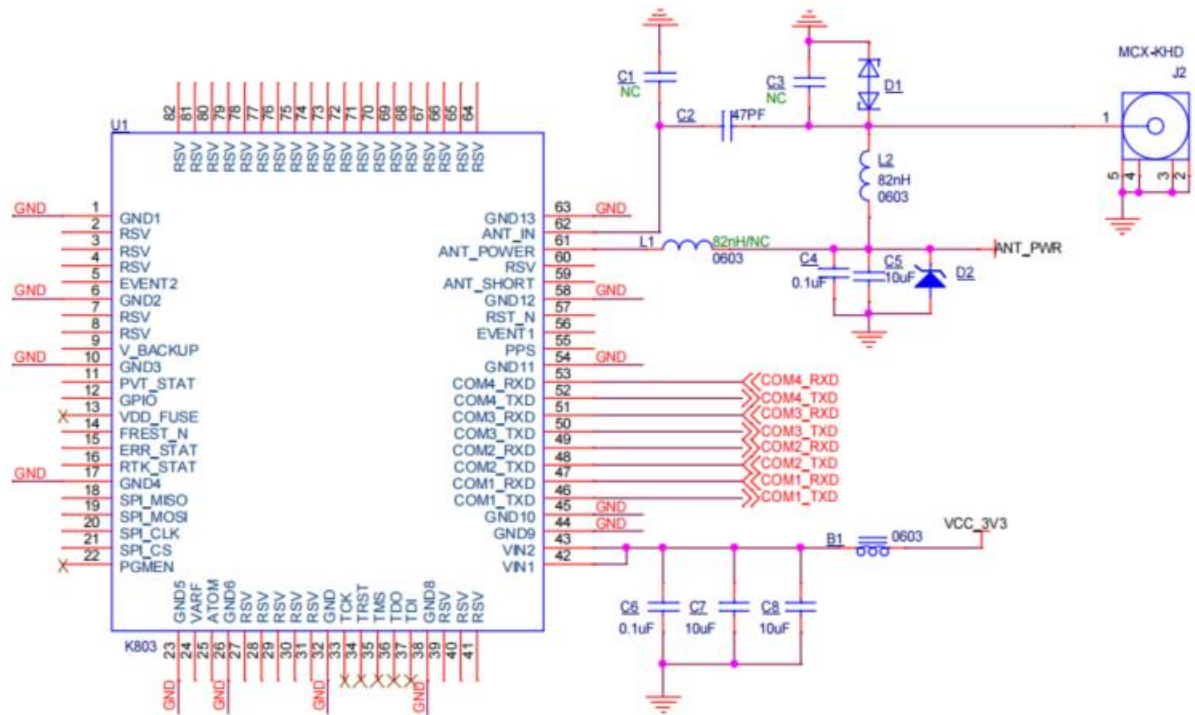


Figure 7. Minimum Hardware Design of QM603 / QM603 最小硬件设计

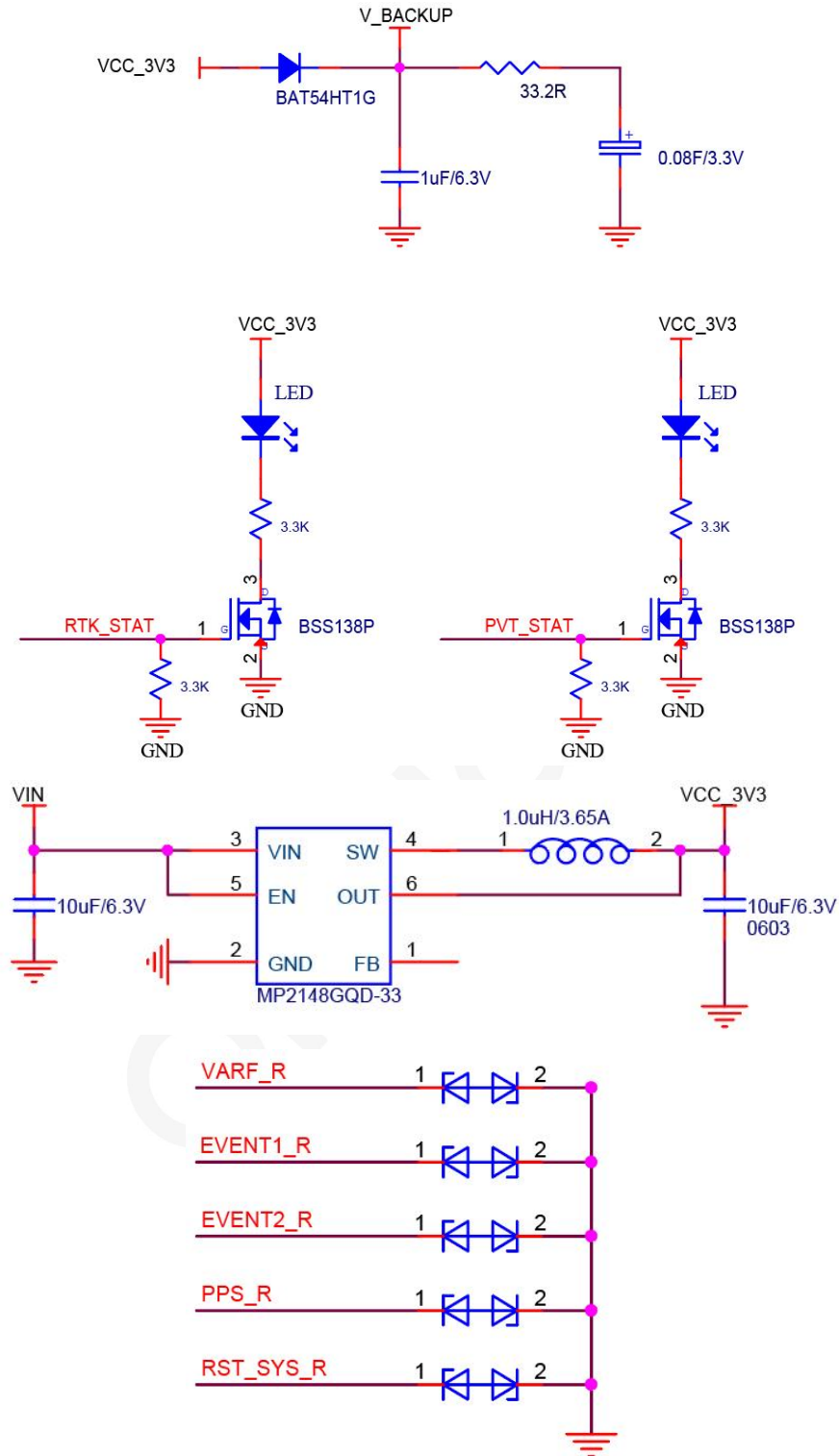


Figure 8. Recommend Design of QM603 / QM603 推荐硬件设计

6. Packaging Information / 包装信息

QM603 modules are packed by pallet, and 100 pieces of QM603 modules are provided in each box.

QM603模块使用托盘方式包装，每盒提供100片QM603模块。

Table 5. QM603 Package Description / QM603包装说明

Project	Description
Module Packaging 模块包装	Number of ESD vacuum bags: 1 Pcs/Box 防静电真空袋数量: 1 个/盒
	Humidity card number: 1 Pcs/Box 湿度卡数量: 1 个/盒
	Quantity of desiccant: 1 Pcs/Box 干燥剂数量: 1 个/盒
	Number of trays: 6 Pcs/Box (Note: Modules are not stored on the top tray) 托盘数量: 6 个/盒 (注: 最上面的托盘上不存放模块)
	Number of modules in each tray: 20 Slice/Plate 每个托盘中模块数量: 20 片/盘
	Module quantity: 100 Slice/Box 模块数量: 100 片/盒

上海钦天导航技术有限公司

QinNav Technology, LTD.

上海市嘉定区澄浏中路618号1号楼B区6楼

6th Floor, Zone B, Building 1, 618 Chengliu Middle Road, Jiading District, Shanghai

官方网站: www.qinnav.com邮箱: qinnav@qinnav.com

热线: 400-060-8030

